

REMARKS

This is a response to the Office Action mailed on December 3, 2002 requiring an election of invention.

The Applicant, through its representatives and attorneys, hereby provisionally elects, with traverse, the invention of Group I, having claims 1-2.

Applicant traverses the Restriction Requirement for the following reasons.

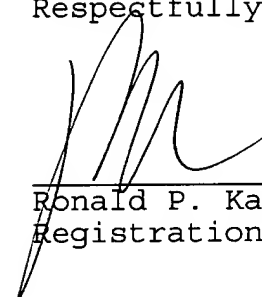
"If the search and examination of an entire application can be made without serious burden, the examiner must examine it on the merits, even though it includes claims to distinct or independent inventions." M.P.E.P. §803.

Upon allowance of claims 1-2, the rejoinder of the claims withdrawn from consideration by the Office Action mailed on December 3, 2002 along with the full examination and issuance of those claims is additionally requested as required by M.P.E.P §821.04.

An early Action on the merits of this application is respectfully requested. If the Examiner has any comments or suggestions that could place this application in even better form, the Examiner is requested to telephone Brian K. Dutton,

Reg. No. 47,255, at 202-955-8753 or the undersigned attorney at the below-listed number.

Respectfully submitted,



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APPENDIX

IN THE CLAIMS

1. A transfer film comprising:
a base film,
a conducting film layer formed on said base film, and
an adhesion layer formed on said conducting film layer.

2. A transfer film comprising:
a base film,
a heat absorption film layer formed on said base film,
a conducting film layer formed on said heat absorption film
layer, and
an adhesion layer formed on said conducting film layer.

3. A method for fabricating a thin film for a display
apparatus panel, comprising the steps of:
disposing a transfer film on said display apparatus panel,
said transfer film being constructed by forming a conducting film
layer on a base film and an adhesion layer on said conducting
film layer, and
heating and pressing said transfer film onto said display
apparatus panel to transfer said conducting film layer to said
display apparatus panel.

4. A method for fabricating a thin film for a display

apparatus panel, comprising the steps of:

disposing a transfer film on said display apparatus panel, said transfer film being constructed by forming a heat absorption film layer on a base film, a conducting film layer on said heat absorption film layer, and an adhesion layer on said conducting film layer, and

heating and pressing said transfer film onto said display apparatus panel to transfer said heat absorption film layer and said conducting film layer to said display apparatus panel.

5. A display apparatus comprising:

a conducting film fabricated by transferring from a transfer film comprising a base film,

a conducting film layer formed on said base film layer, and an adhesion layer formed on said conducting film layer.

6. A display apparatus comprising:

a conducting film and a heat absorption film fabricated by transferring from a transfer film comprising a base film, a heat absorption film layer formed on said base film, a conducting film layer formed on said heat absorption film layer, and an adhesion layer formed on said conducting film layer.

7. A method for fabricating a film for a display apparatus panel, comprising the steps of:

disposing a transfer film on said display apparatus panel,

said transfer film having said film to be attached on said display apparatus panel, and

heating and pressing said transfer film onto said display apparatus panel.

Please add the following new claims.

8. (new) The transfer film of claim 1, further comprising:
a cushion film formed between said base film and said conducting film layer, the adhesiveness of said cushion film to said base film being stronger than the adhesiveness of said cushion film to said conducting film layer.

9. (new) The transfer film of claim 8, wherein said cushion film is in contact with said base film.

10. (new) The transfer film of claim 1, further comprising:
a cover film, said adhesion layer being between said conducting film layer and said cover film.

11. (new) The transfer film of claim 1, wherein said base film consists essentially of polyethylene terephthalate (PET).

12. (new) The transfer film of claim 1, wherein said conducting film layer is a metal back film.

13. (new) The transfer film of claim 1, wherein said conducting film layer is composed of aluminum.

14. (new) The transfer film of claim 1, wherein said adhesion layer is in contact with said conducting film layer.

15. (new) The transfer film of claim 1, wherein said adhesion layer is adapted for adherence to an inside surface of a cathode ray tube.

16. (new) The transfer film of claim 2, further comprising:
a cushion film formed between said base film and said heat absorption film layer, the adhesiveness of said cushion film to said base film being stronger than the adhesiveness of said cushion film to said heat absorption film layer.

17. (new) The transfer film of claim 16, wherein said cushion film is in contact with said base film.

18. (new) The transfer film of claim 2, further comprising:
a cover film, said adhesion layer being between said conducting film layer and said cover film.

19. (new) The transfer film of claim 2, wherein said heat absorption film layer, when disposed onto a cathode ray tube, absorbs heat from an aperture grille.

20. (new) The transfer film of claim 2, wherein said heat absorption film layer composed of a black color film of graphite.

21. (new) The transfer film of claim 2, wherein said base film consists essentially of polyethylene terephthalate (PET).

22. (new) The transfer film of claim 2, wherein said conducting film layer is a metal back film.

23. (new) The transfer film of claim 2, wherein said conducting film layer is composed of aluminum.

24. (new) The transfer film of claim 2, wherein said adhesion layer is in contact with said conducting film layer.

25. (new) The transfer film of claim 2, wherein said adhesion layer is adapted for adherence to an inside surface of a cathode ray tube.